Forward Tracking; physics case, challenges and design

Forward Tracking; physics case, challenges and design

The 3rd ILD Workshop February 16 - 18, 2009 Ewha Womans University, Seoul, Korea





Marcel Vos (IFIC – U. Valencia/CSIC)

on behalf of ILC-Spain

Coordinated ILC effort in Spain







Strong Spanish participation in DEPFET IFIC (since 2005) USC, UB, URL, CNM (since 2008)

Silicon for Large Colliders

IFIC, IFCA, UB, CNM, USC one EUDET member, several associates

CALICE CIEMAT Madrid

Coordinated effort (led by A. Ruiz):

- regular meetings
- funding/projects
- R&D interests
- the forward tracker

The scope of this talk



3

ILD's Forward Tracking Disks The forward region = $6^{\circ} < \theta < 25^{\circ}$ (0.1 rad < $\theta < 0.45$ rad, 0.9 < cos $\theta < 0.995$, 1.5 < $|\eta| < 3$) in future e⁺e⁻ colliders in 0.5-1 TeV range jjį

Why is forward tracking performance important?

There is a series of very relevant physics processes where final state particles are predominantly emitted at small polar angle Mostly electrons, but also muons, t, b- and c-jets

From LEP-I to the ILC (to CLIC)



Determine the relevance of the forward region in several key processes for a number of scenarios increasing center-of-mass energy



3rd ILD workshop, Seoul, Feb 2009

Marcel.Vos@ific.uv.es

Multi-fermion final states



Final states with many fermionsb(like ordinary SM tt-events) are hardly ever fully contained in the central detector

Ρ(θ < 30)	√s = 500 GeV	$\sqrt{s} = 1 \text{ TeV}$	$\sqrt{s} = 3 \text{ TeV}$
at least one top	0.15	0.17	0.22
at least one b	0.22	0.25	0.25
any fermion	0.59	0.51	0.4

Tag a forward b-jet in 1 out of 4 events: requires vertexing

With increasing center-of-mass energy (from LEP-I to to LEP-II to ILC to CLIC) the importance of the t-channel increases

Example: scalar lepton production in SUSY (SPS benchmark point 1a)





The importance of the t-channel

polar angle distribution for s-lepton production





Products from t-channel prefer the forward region (and increasingly so with higher center-of-mass energy) Fraction of forward s-electrons ($\theta < 30^{\circ}$) for s-electron pair production in SPS1a @ 500 GeV 24 % @ 1 TeV 50 %

Scan SUSY space (analytical expression for polar angle distribution)

polar angle θ (degrees)

8

The challenge



The last example: di-boson production Polar angle distribution of electrons extre peaked in forward direction

Next: Study a representative list of be channels in a quantitative way (to be published soon)



Forward tracking requirements at the next $e^+e^$ collider part I: the physics case for forward tracking

J. Fuster ^v, S. Heinemeyer ^s, C. Lacasta ^v, C. Mariñas ^v, A. Ruiz ^s, M. Vos ^{v*}

 s IFCA Santander

^v IFIC Valencia

February 12, 2009

Abstract

In this note we explore the detector requirements of the forward tracking region for a future e^+e^- collider with a center-of-mass energy in the range from 500 GeV to 3 TeV. The relevance of the forward region is explored for a wide range of physics processes.

Forward tracking physics case:

Little guidance from standard benchmark reactions ($\cos \theta < 0.95$) In this document some physics cases are explored that are particularly relevant for this detector region.

Why is forward tracking challenging?

The material! Hermetic coverage Significant background at smallest radii The unfavorable orientation of the magnetic field Abundant low momentum tracks – pattern recognition

Coverage



Coverage



Environment: background level



Incoherent e⁺e⁻ pair production off beamstrahlung photons produces a very large number of electrons and positrons each BX. The large majority is soft and/or emitted at low angle and are trapped in the "accumulation zone"



14

Pair background



Hit density = number of GEANT4 energy deposits per unit area per ILC bunch crossing Does not take into account the number of channels fired by a single hit

	Typical area sensitive elements	time resolution:
pixel:	25 x 25 μ m ² = 6.25 x 10 ⁻⁴ mm ²	100 BX
strips:	50 μ m x 10 cm = 0.5 mm ²	1 BX



3rd ILD workshop, Seoul, Feb 2009

Detector specifications

ILC detectors: intentions

VXD: impact parameter resolution $5 - 10 \,\mu$ m.

This precision is required to achieve excellent heavy flavour tagging, particularly for couplings of the Higgs boson to charm ($c\tau \sim 150 \ \mu m$) and bottom ($c\tau \sim 450 \ \mu m$) Resolution in central region well understood. Forward region more complex...

TRK: momentum resolution $\Delta(1/p_{T}) < 5 \times 10^{-5}$ (GeV⁻¹)

Precision required to reconstruct the Higgs boson using the recoil method, and to reconstruct SUSY end-points long-standing fast simulation results in central and forward region confronted to ILD_00 full simulation (single muon samples) and FullLDCTracking

17

CALO: energy resolution $\Delta E/E < 30\%/\sqrt{E}$

Precision required to distinguish hadronic decays of W and Z Impact of tracker in central region well understood. Contribution to forward region expected. Transverse momentum resolution versus polar angle Measured on three single-muon samples with fixed |p|



FullLDCTracking on ILD00 (Mokka/MarlinReco) Vos/Duarte/Iglesias

CMS KF Track Fit on standalone FTD Vos/Duarte/Iglesias



Impact parameter





* I 35 < θ < 90 5 VXD + SIT * II 25.8 < θ < 35 5 VXD + FTD1 * III 18.5 < θ < 25.8 3 VXD + FTD1+2 * V 10 < θ < 12.5 FTD1,... * IV 12.5 < θ < 18.5 VXD2 + FTD * VI 6.5 < θ < 10.0 FTD2,...

3rd ILD workshop, Seoul, Feb 2009

Marcel.Vos@ific.uv.es

Transverse impact parameter resolution versus polar angle Measured on three single-muon samples with fixed |p|

- LiCToy on ILD00 (full KF fit), M. Valentan, HEPHY Vienna
- FullLDCTracking on ILD00 (Mokka/MarlinReco) Vos/Duarte/Iglesias

CMS KF Track Fit on standalone FTD Vos/Duarte/Iglesias



Towards an engineered design

Calibration/alignment Mechanical support Services

Laser alignment system

Marcos Fernandez, IFCA

→ Laser alignment system (AMS/CMS)

- ▶ Near IR laser beam provides pseudo-track
- ▶ No mechanical transfer between aligned object (i.e. jewel) and sensor
- Minimal distortion of system (laser brought into the detector along a fiber)
- → Develop IR transparent μ -strip detector:

Identify a *minimum* set modifications in detector structure to increase its optical transmittance in NIR spectrum up to 70-80 %
design and produce IR-transparent Silicon microstrip detectors IFCA (Santander)/IMB-CNM (Barcelona)

•Consider option of aluminum electrodes or transparent electrodes

EUDET prototype AMS-like

Implemented:

- Ø~10 mm window where Al back-metalization has bee Suggested (not cost effective for small batches):
 - Strip width reduction (in alignment window)
 - Alternate strip removal (in alignment window)



Laser alignment system

• **IMB-CNM** Barcelona provides **samples** of each of the materials. Manufacturing and processing granted by Spanish Program to Access Large Research Facilities (ICTS).

Shown to the right wafers from **TOPSIL**, (high resistivity, double polished, $300\pm 20 \ \mu m$ thick).

- Different wafers have different doping levels
- Wafers divided into quadrants.
- In each quadrant only one new material has been deposited.
- We also have one wafer with pad sensors and no backmetal to study the effect of diffraction at strips
- Also available a raw wafer (unprocessed)
- The goals of these measurements are:



- -Characterize each material as produced by the manufacturer
- Study **thickness tolerances** of the materials and, if needed, establish upper limits
- Study of transparent electrodes as a solution for the strips of the sensor

Marcos Fernandez, IFCA

Simulation



Simulation of IR properties of silicon sensors now sufficiently mature to design and manufacture prototype sensors

If needed, technology transfer to larger manufacturer

Towards an FTD design

- → Micro-strip module guidelines:
 - ▶ ROC on sensor
 - **x** ROC thinned to 50-100 um
 - **v** 6" wafers (approx 10 cm x 10 cm sensors)
 - 💊 150 μ m thickness
 - ▶ Two sensor layers per disk.







Conclusions

Interest of the forward region:

in several interesting physics cases the final state products have a strong preference for the forward region

Specific challenges:

momentum resolution under unfavorable field orientation impact parameter measurement for very forward tracks non-negligible background level (read-out speed) standalone pattern recognition (background, low p tracks) minimal distortion of particles/global performance

Requirements:

granularity @ reasonable speed staying within the power budget

Laser alignment:

the only "many-layer" silicon system in ILD

Towards a design:

engineering studies of FTD

More information on http://ific.uv.es/~vos/ilc



REFERENCES

A. Savoy Navarro et al. (the SiLC collaboration), PRC review, DESY, 2008

A. Savoy Navarro et al. (the SiLC collaboration), ILC tracking review, Beijing 2007

The challenges of forward tracking, invited talk, IEEE NSS&MIC, Dresden, Germany, 2008

Forward tracking, TILC08 (ACFA/EDG) Sendai, Japan, 2008

The silicon tracker elements, ILD meeting, Sendai, Japan, 2008

Forward Tracking, SiD meeting, Oxford, UK, 2008

The silicon tracker, First ILD workshop, Desy Zeuthen, Germany, 2008

Tracking and alignment at the ILC, *invited talk*, 2nd alignment workshop for the LHC, CERN, Ginebra, Switzerland, 2007

Tracking at the ILC, invited talk, 8th International Conference on Large Scale Applications and Radiation Hardness of Semiconductor Detectors, published Nucl. Instr. Meth.,

Overview of SiLC simulation, Linear Collider Workshop (LCWS07), *DESY (Germany), 2007,* arXiv:0801.4509

The SiLC simulation task force, ILC software workshop, Orsay, France, 2007

The SiLC simulation task force, Tracking review, "the SiLC collaboration",, Beijing, China, 2007